

# 74ABT126

Quad buffer; 3-state

Rev. 5 — 4 April 2017

Product data sheet

## 1 General description

The 74ABT126 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT126 device is a quad buffer that is ideal for driving bus lines. The device features four output enable inputs (nOE) each controlling one of the 3-state outputs (nY).

## 2 Features and benefits

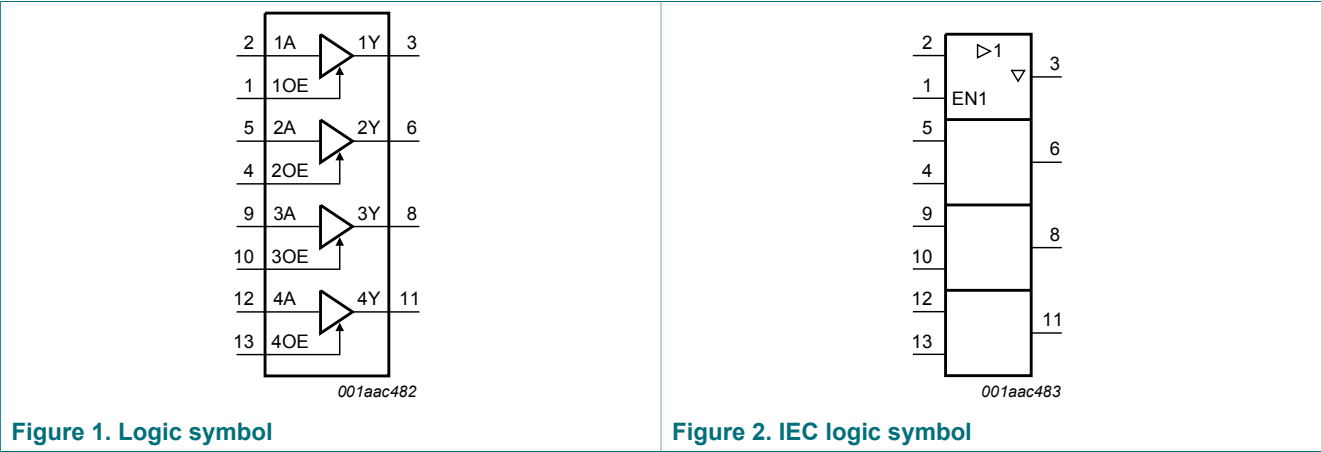
- Quad bus interface
- 3-state buffers
- Live insertion and extraction permitted
- Output capability: +64 mA and -32 mA
- Inputs are disabled during 3-state mode
- Power-up 3-state
- Latch-up protection:
  - JESD78: exceeds 500 mA
- ESD protection:
  - MIL STD 883 method 3015: exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V

## 3 Ordering information

Table 1. Ordering information

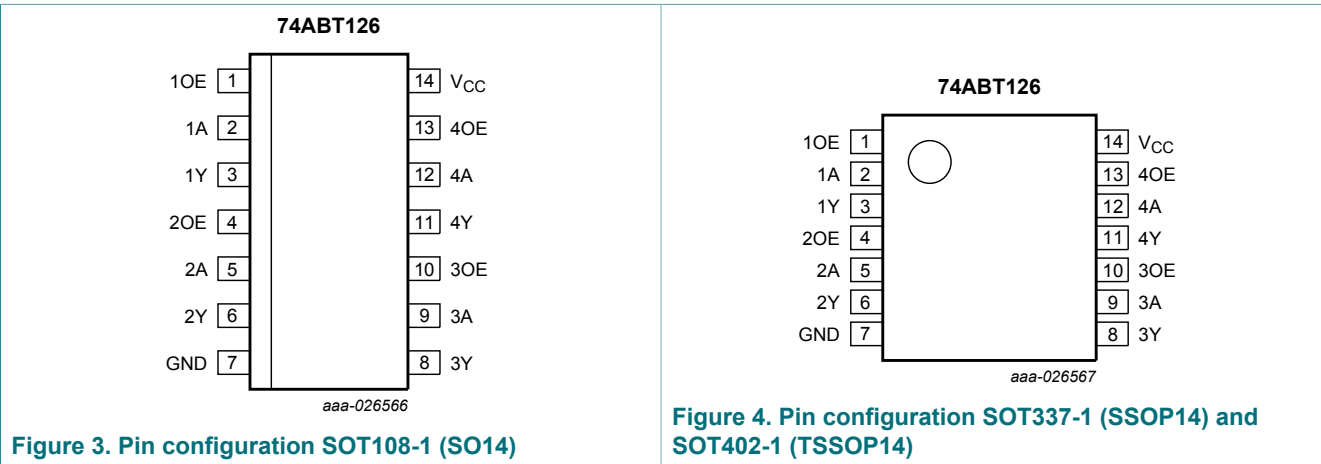
| Type number | Package           |         |   |          |
|-------------|-------------------|---------|---|----------|
|             | Temperature range | Name    | Description   | Version  |
| 74ABT126D   | -40 °C to +85 °C  | SO14    | plastic small outline package; 14 leads; body width 3.9 mm        | SOT108-1 |
| 74ABT126DB  | -40 °C to +85 °C  | SSOP14  | plastic shrink small outline package; 14 leads; body width 5.3 mm | SOT337-1 |
| 74ABT126PW  | -40 °C to +85 °C  | TSSOP14 | plastic thin small outline package; 14 leads; body width 4.4 mm   | SOT402-1 |

4 Functional diagram



5 Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol             | Pin          | Description          |
|--------------------|--------------|----------------------|
| 1OE, 2OE, 3OE, 4OE | 1, 4, 10, 13 | output enable inputs |
| 1A, 2A, 3A, 4A     | 2, 5, 9, 12  | data inputs          |
| 1Y, 2Y, 3Y, 4Y     | 3, 6, 8, 11  | data outputs         |
| GND                | 7            | ground (0 V)         |
| V <sub>CC</sub>    | 14           | supply voltage       |

## 6 Functional description

Table 3. Function table <sup>[1]</sup>

| Input |    | Output |
|-------|----|--------|
| nOE   | nA | nY     |
| H     | L  | L      |
| H     | H  | H      |
| L     | X  | Z      |

- [1] H = HIGH voltage level;  
 L = LOW voltage level;  
 X = don't care;  
 Z = high-impedance OFF-state.

## 7 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions                        | Min                 | Max  | Unit |
|------------------|-------------------------|-----------------------------------|---------------------|------|------|
| V <sub>CC</sub>  | supply voltage          |                                   | -0.5                | +7.0 | V    |
| V <sub>I</sub>   | input voltage           |                                   | <sup>[1]</sup> -1.2 | +7.0 | V    |
| V <sub>O</sub>   | output voltage          | output in OFF-state or HIGH-state | <sup>[1]</sup> -0.5 | +5.5 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V              | -18                 | -    | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < 0 V              | -50                 | -    | mA   |
| I <sub>O</sub>   | output current          | output in LOW-state               | -                   | 128  | mA   |
| T <sub>j</sub>   | junction temperature    |                                   | <sup>[2]</sup> -    | 150  | °C   |
| T <sub>stg</sub> | storage temperature     |                                   | -65                 | +150 | °C   |

- [1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- [2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

## 8 Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol           | Parameter                           | Conditions  | Min | Typ | Max             | Unit |
|------------------|-------------------------------------|-------------|-----|-----|-----------------|------|
| V <sub>CC</sub>  | supply voltage                      |             | 4.5 | -   | 5.5             | V    |
| V <sub>I</sub>   | input voltage                       |             | 0   | -   | V <sub>CC</sub> | V    |
| I <sub>OH</sub>  | HIGH-level output current           |             | -32 | -   | -               | mA   |
| I <sub>OL</sub>  | LOW-level output current            |             | -   | -   | 64              | mA   |
| Δt/ΔV            | input transition rise and fall rate |             | 0   | -   | 10              | ns/V |
| T <sub>amb</sub> | ambient temperature                 | in free air | -40 | -   | +85             | °C   |

## 9 Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                | Parameter                          | Conditions   | T <sub>amb</sub> = 25 °C |       |      | T <sub>amb</sub> = -45 °C to +85 °C |      | Unit |
|-----------------------|------------------------------------|--|--------------------------|-------|------|-------------------------------------|------|------|
|                       |                                    |  | Min                      | Typ   | Max  | Min                                 | Max  |      |
| V <sub>IK</sub>       | input clamping voltage             | V <sub>CC</sub> = 4.5 V; I <sub>IK</sub> = -18 mA  | -1.2                     | -0.9  | -    | -1.2                                | -    | V    |
| V <sub>IH</sub>       | HIGH-level input voltage           |  | 2.0                      | -     | -    | 2.0                                 | -    | V    |
| V <sub>IL</sub>       | LOW-level input voltage            |  | -                        | -     | 0.8  | -                                   | 0.8  | V    |
| V <sub>OH</sub>       | HIGH-level output voltage          | V <sub>CC</sub> = 4.5 V; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>   |                          |       |      |                                     |      |      |
|                       |                                    | I <sub>OH</sub> = -3 mA  | 2.5                      | 2.9   | -    | 2.5                                 | -    | V    |
|                       |                                    | I <sub>OH</sub> = -32 mA   | 2.0                      | 2.4   | -    | 2.0                                 | -    | V    |
|                       |                                    | V <sub>CC</sub> = 5.0 V; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>   |                          |       |      |                                     |      |      |
|                       |                                    | I <sub>OH</sub> = -3 mA  | 3.0                      | 3.4   | -    | 3.0                                 | -    | V    |
| V <sub>OL</sub>       | LOW-level output voltage           | V <sub>CC</sub> = 4.5 V; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>   |                          |       |      |                                     |      |      |
|                       |                                    | I <sub>OL</sub> = 64 mA  | -                        | 0.35  | 0.55 | -                                   | 0.55 | V    |
| I <sub>I</sub>        | input leakage current              | V <sub>CC</sub> = 5.5 V; V <sub>I</sub> = GND or 5.5 V   | -                        | ±0.01 | ±1.0 | -                                   | ±1.0 | µA   |
| I <sub>OFF</sub>      | power-off leakage current          | V <sub>CC</sub> = 0 V; V <sub>O</sub> or V <sub>I</sub> ≤ 4.5 V  | -                        | ±5.0  | ±100 | -                                   | ±100 | µA   |
| I <sub>O(pu/pd)</sub> | power-up/power-down output current | V <sub>CC</sub> = 2.1 V; V <sub>O</sub> = 0.5 V; V <sub>I</sub> = GND or V <sub>CC</sub> ; nOE = don't care <sup>[1]</sup> | -                        | ±5.0  | ±50  | -                                   | ±50  | µA   |
| I <sub>OZ</sub>       | OFF-state output current           | V <sub>CC</sub> = 5.5 V; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>   |                          |       |      |                                     |      |      |
|                       |                                    | output HIGH-state at V <sub>O</sub> = 2.7 V  | -                        | 1.0   | 50   | -                                   | 50   | µA   |
|                       |                                    | output LOW-state at V <sub>O</sub> = 0.5 V   | -50                      | -1.0  | -    | -50                                 | -    | µA   |
| I <sub>CEX</sub>      | output high leakage current        | V <sub>CC</sub> = 5.5 V; V <sub>O</sub> = 5.5 V; V <sub>I</sub> = GND or V <sub>CC</sub>                                   | -                        | 5.0   | 50   | -                                   | 50   | µA   |
| I <sub>O</sub>        | output current                     | V <sub>CC</sub> = 5.5 V; V <sub>O</sub> = 2.5 V <sup>[2]</sup>   | -180                     | -100  | -50  | -180                                | -50  | mA   |
| I <sub>CC</sub>       | supply current                     | V <sub>CC</sub> = 5.5 V; V <sub>I</sub> = GND or V <sub>CC</sub>   |                          |       |      |                                     |      |      |
|                       |                                    | outputs HIGH-state   | -                        | 65    | 250  | -                                   | 250  | µA   |
|                       |                                    | outputs LOW-state  | -                        | 12    | 15   | -                                   | 15   | mA   |
|                       |                                    | outputs 3-state  | -                        | 65    | 250  | -                                   | 250  | µA   |
| ΔI <sub>CC</sub>      | additional supply current          |  |                          |       |      |                                     |      |      |
|                       |                                    | per data input pin   |                          |       |      |                                     |      |      |
|                       |                                    | one data input at 3.4 V and other inputs at V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V <sup>[3]</sup>                 |                          |       |      |                                     |      |      |
|                       |                                    | outputs enabled  | -                        | 0.5   | 1.5  | -                                   | 1.5  | mA   |
|                       |                                    | outputs 3-state  | -                        | 50    | 250  | -                                   | 250  | µA   |

| Symbol         | Parameter            | Conditions   | T <sub>amb</sub> = 25 °C |     |     | T <sub>amb</sub> = -45 °C to +85 °C |     | Unit |
|----------------|----------------------|--|--------------------------|-----|-----|-------------------------------------|-----|------|
|                |                      |  | Min                      | Typ | Max | Min                                 | Max |      |
|                | per enable input pin | one enable input at 3.4 V and other inputs at V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V <sup>[3]</sup> |                          |     |     |                                     |     |      |
|                |                      | outputs 3-state  | -                        | 0.5 | 1.5 | -                                   | 1.5 | mA   |
| C <sub>I</sub> | input capacitance    | V <sub>I</sub> = 0 V or V <sub>CC</sub>  | -                        | 4   | -   | -                                   | -   | pF   |
| C <sub>O</sub> | output capacitance   | outputs disabled; V <sub>O</sub> = 0 V or V <sub>CC</sub>  | -                        | 7   | -   | -                                   | -   | pF   |

[1] This parameter is valid for any V<sub>CC</sub> between 0 V and 2.1 V, with a transition time of up to 10 ms. From V<sub>CC</sub> = 2.1 V to V<sub>CC</sub> = 5 V ± 10 % a transition time of up to 100 µs is permitted.

[2] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[3] This is the increase in supply current for each input at 3.4 V.

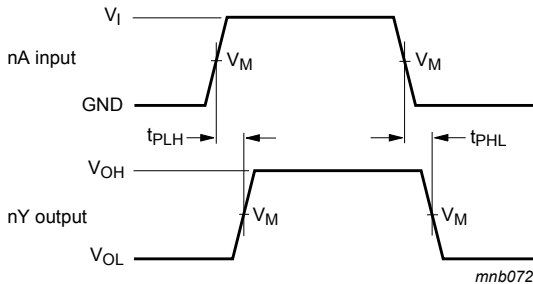
## 10 Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 7](#).

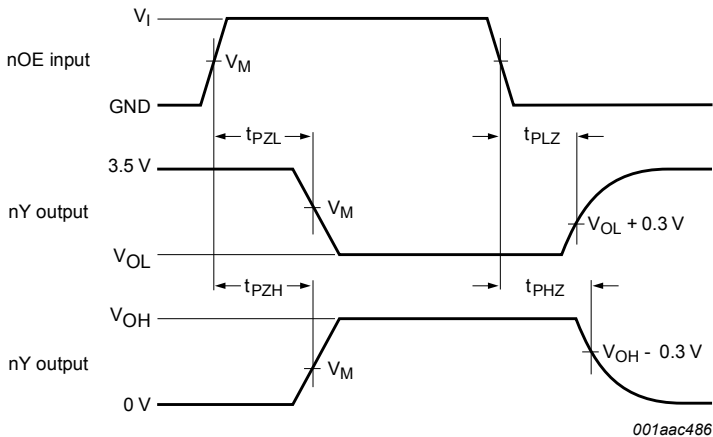
| Symbol           | Parameter                           | Conditions                             | T <sub>amb</sub> = 25 °C;<br>V <sub>CC</sub> = 5.0 V |     |     | T <sub>amb</sub> = -40 °C to +85 °C;<br>V <sub>CC</sub> = 5.0 V ± 0.5 V |     | Unit |
|------------------|-------------------------------------|--|--|-----|-----|---|-----|------|
|                  |                                     |  | Min  | Typ | Max | Min   | Max |      |
| t <sub>PLH</sub> | LOW to HIGH propagation delay       | nA to nY; see <a href="#">Figure 5</a> | 1.0  | 2.9 | 4.2 | 1.0   | 4.4 | ns   |
| t <sub>PHL</sub> | HIGH to LOW propagation delay       | nA to nY; see <a href="#">Figure 5</a> | 1.0  | 3.0 | 4.3 | 1.0   | 4.6 | ns   |
| t <sub>PZH</sub> | OFF-state to HIGH propagation delay | see <a href="#">Figure 6</a>           | 1.5  | 3.2 | 5.8 | 1.5   | 6.5 | ns   |
| t <sub>PZL</sub> | OFF-state to LOW propagation delay  | see <a href="#">Figure 6</a>           | 1.9  | 4.4 | 5.9 | 1.9   | 6.5 | ns   |
| t <sub>PHZ</sub> | HIGH to OFF-state propagation delay | see <a href="#">Figure 6</a>           | 1.0  | 4.2 | 5.2 | 1.0   | 5.8 | ns   |
| t <sub>PLZ</sub> | LOW to OFF-state propagation delay  | see <a href="#">Figure 6</a>           | 1.0  | 2.9 | 4.9 | 1.0   | 5.5 | ns   |

10.1 Waveforms and test circuit



Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.

Figure 5. Propagation delay input (nA) to output (nY)



Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.

Figure 6. Enable and disable times of 3-state outputs

Table 8. Measurement points

| Input | Output |
|-------|--------|
| $V_M$ | $V_M$  |
| 1.5 V | 1.5 V  |

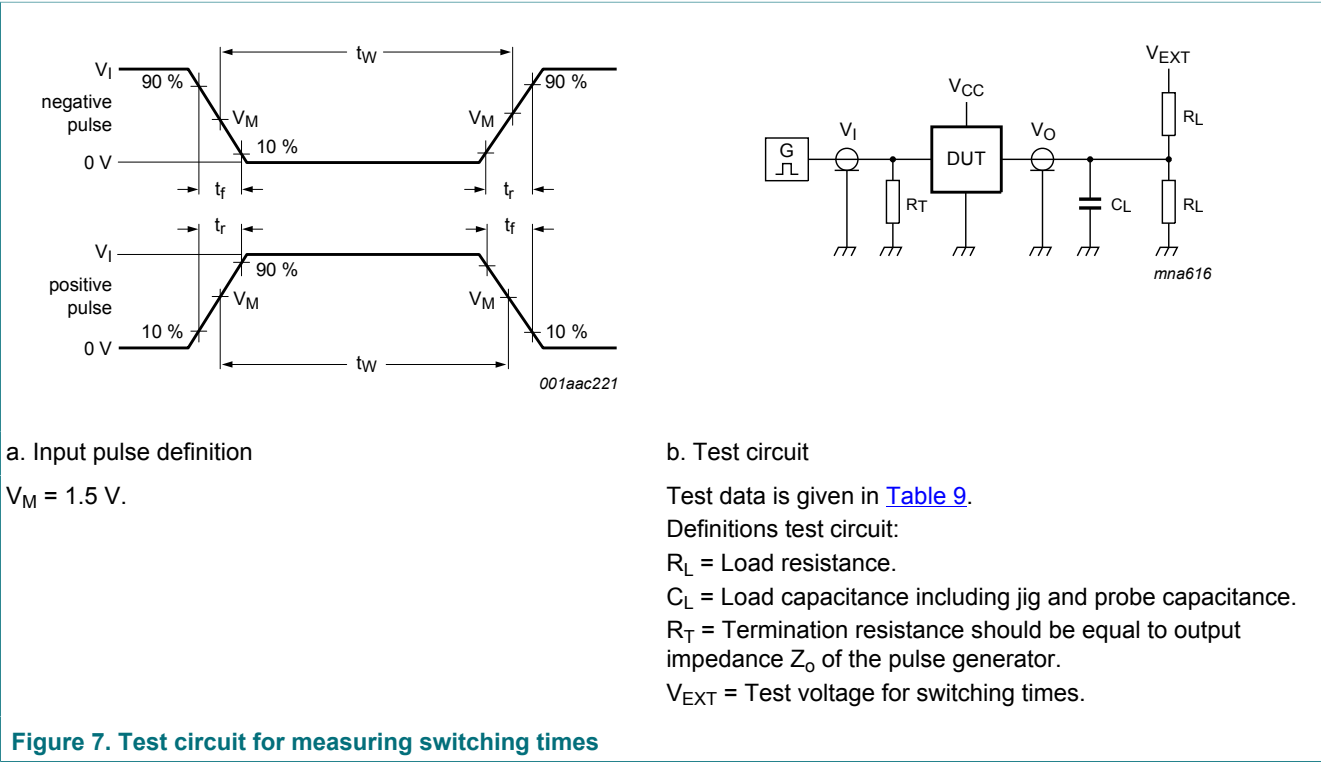


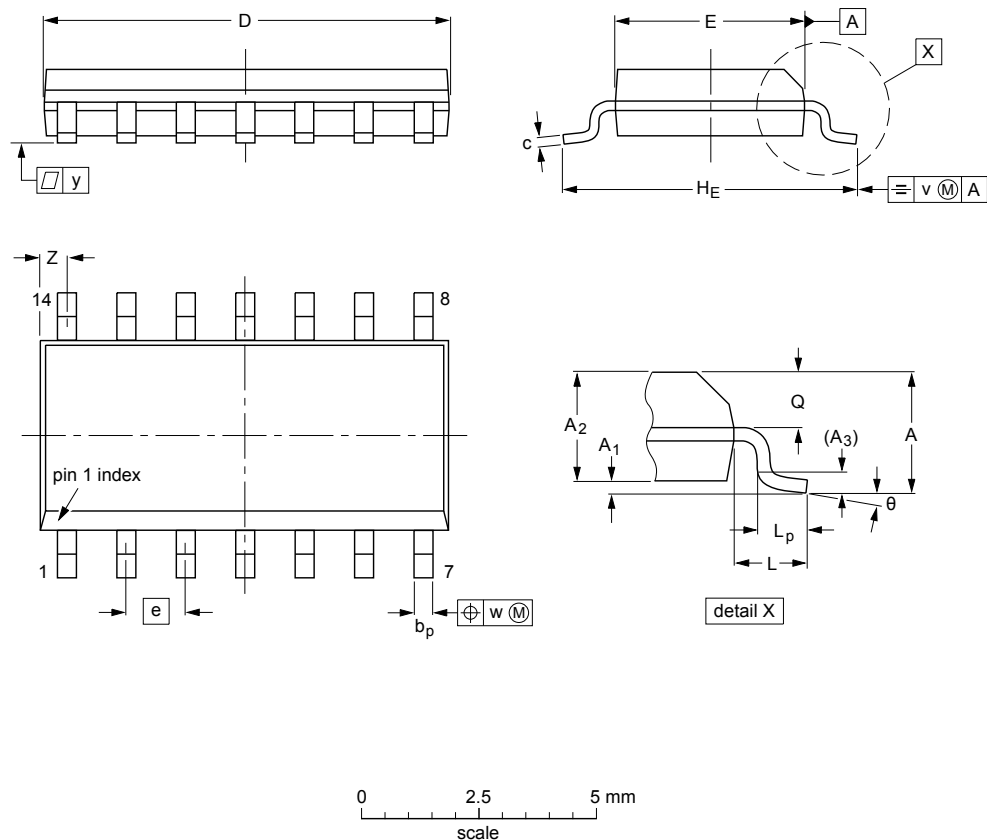
Table 9. Test data

| Input |                     |        |                      | Load  |              | $V_{EXT}$          |                    |                    |
|-------|---------------------|--------|----------------------|-------|--------------|--------------------|--------------------|--------------------|
| $V_I$ | $f_i$               | $t_W$  | $t_r, t_f$           | $C_L$ | $R_L$        | $t_{PHZ}, t_{PZH}$ | $t_{PLZ}, t_{PZL}$ | $t_{PLH}, t_{PHL}$ |
| 3.0 V | $\leq 1\text{ MHz}$ | 500 ns | $\leq 2.5\text{ ns}$ | 50 pF | 500 $\Omega$ | open               | 7.0 V              | open               |

11 Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c                | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | H <sub>E</sub> | L     | L <sub>p</sub> | Q              | v    | w    | y     | Z <sup>(1)</sup> | θ        |
|--------|-----------|----------------|----------------|----------------|----------------|------------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm     | 1.75      | 0.25<br>0.10   | 1.45<br>1.25   | 0.25           | 0.49<br>0.36   | 0.25<br>0.19     | 8.75<br>8.55     | 4.0<br>3.8       | 1.27 | 6.2<br>5.8     | 1.05  | 1.0<br>0.4     | 0.7<br>0.6     | 0.25 | 0.25 | 0.1   | 0.7<br>0.3       | 8°<br>0° |
| inches | 0.069     | 0.010<br>0.004 | 0.057<br>0.049 | 0.01           | 0.019<br>0.014 | 0.0100<br>0.0075 | 0.35<br>0.34     | 0.16<br>0.15     | 0.05 | 0.244<br>0.228 | 0.041 | 0.039<br>0.016 | 0.028<br>0.024 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012   |          |

Note

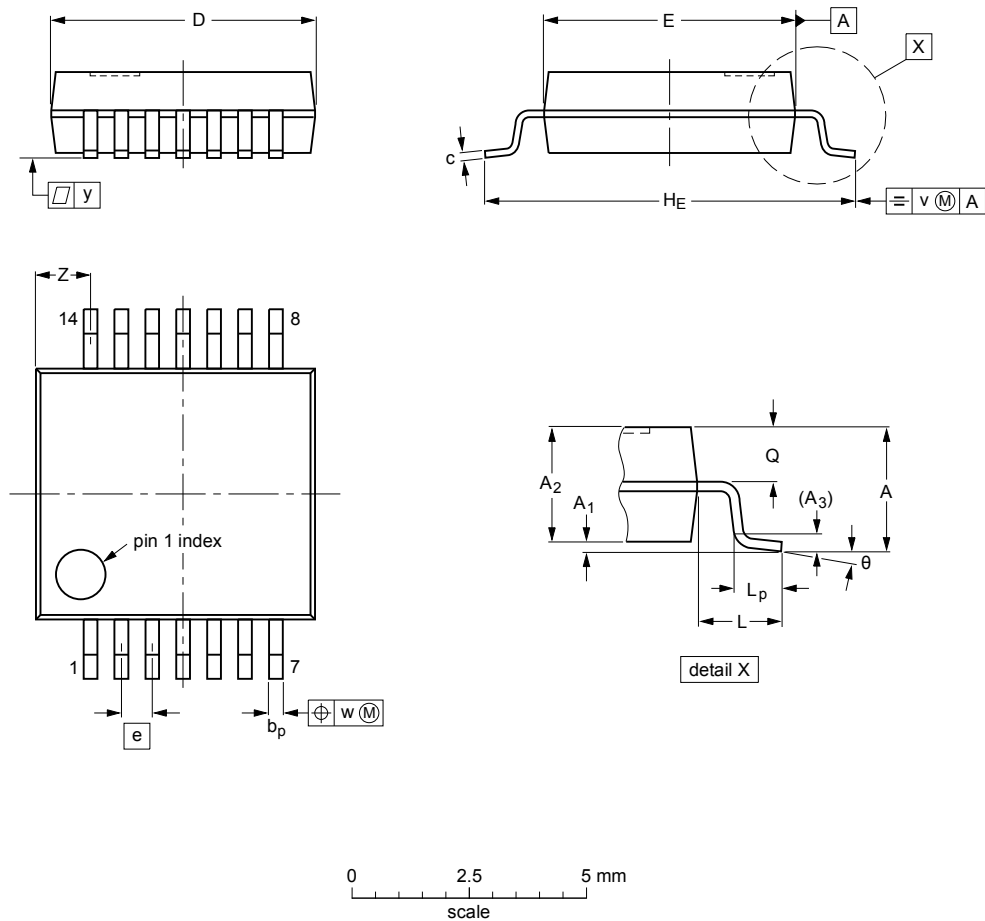
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                      |
| SOT108-1           | 076E06     | MS-012 |       |  |                        | 99-12-27<br>03-02-19 |

Figure 8. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c            | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | H <sub>E</sub> | L    | L <sub>p</sub> | Q          | v   | w    | y   | z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm   | 2         | 0.21<br>0.05   | 1.80<br>1.65   | 0.25           | 0.38<br>0.25   | 0.20<br>0.09 | 6.4<br>6.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6     | 1.25 | 1.03<br>0.63   | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 1.4<br>0.9       | 8°<br>0° |

Note

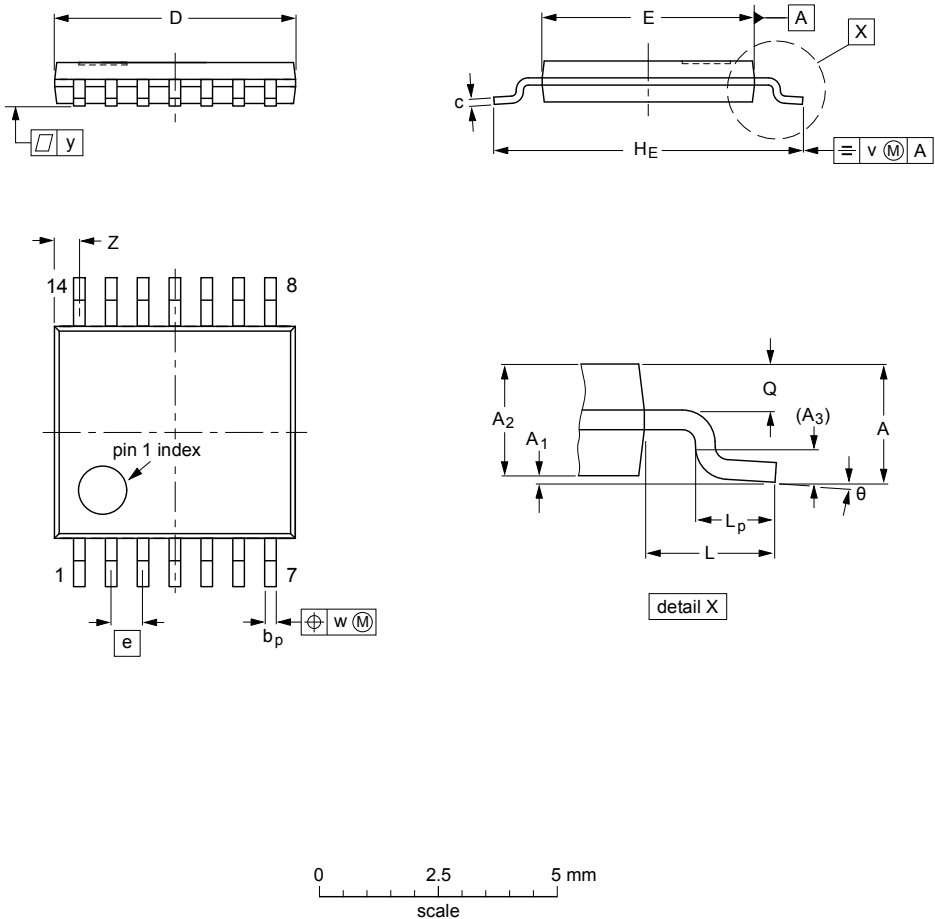
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE            |
|--------------------|------------|--------|-------|--|------------------------|-----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                       |
| SOT337-1           |            | MO-150 |       |  |                        | -99-12-27<br>03-02-19 |

Figure 9. Package outline SOT337-1 (SSOP14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A <sub>max.</sub> | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c          | D <sup>(1)</sup> | E <sup>(2)</sup> | e    | H <sub>E</sub> | L | L <sub>p</sub> | Q          | v   | w    | y   | Z <sup>(1)</sup> | θ        |
|------|-------------------|----------------|----------------|----------------|----------------|------------|------------------|------------------|------|----------------|---|----------------|------------|-----|------|-----|------------------|----------|
| mm   | 1.1               | 0.15<br>0.05   | 0.95<br>0.80   | 0.25           | 0.30<br>0.19   | 0.2<br>0.1 | 5.1<br>4.9       | 4.5<br>4.3       | 0.65 | 6.6<br>6.2     | 1 | 0.75<br>0.50   | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.72<br>0.38     | 8°<br>0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE             |
|--------------------|------------|--------|-------|--|------------------------|------------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                        |
| SOT402-1           |            | MO-153 |       |  |                        | -99-12-27-<br>03-02-18 |

Figure 10. Package outline SOT402-1 (TSSOP14)

## 12 Abbreviations

Table 10. Abbreviations

| Acronym | Description                                     |
|---------|---|
| BiCMOS  | Bipolar Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                               |
| ESD     | ElectroStatic Discharge                         |
| MIL     | Military  |
| MM      | Machine Model                                   |

## 13 Revision history

Table 11. Revision history

| Document ID    | Release date  | Data sheet status     | Change notice | Supersedes   |
|----------------|---|-----------------------|---------------|--------------|
| 74ABT126 v.5   | 20170404  | Product data sheet    | -             | 74ABT126 v.4 |
| Modifications: | <ul style="list-style-type: none"><li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li><li>Legal texts have been adapted to the new company name where appropriate.</li></ul>  |                       |               |              |
| 74ABT126 v.4   | 20050217  | Product data sheet    | -             | 74ABT126 v.3 |
| Modifications: | <ul style="list-style-type: none"><li>The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors.</li><li><a href="#">Section 2</a>: modified 'JEDEC Std 17' into 'JESD78'.</li><li><a href="#">Table 7</a>: changed min value of <math>t_{PZH}</math> from 1.9 ns into 1.5 ns for both conditions <math>V_{CC} = 5.0\text{ V}</math> at <math>T_{amb} = 25\text{ °C}</math> and <math>V_{CC} = 5.0\text{ V} \pm 0.5\text{ V}</math> at <math>T_{amb} = -40\text{ °C}</math> to <math>+85\text{ °C}</math>.</li></ul> |                       |               |              |
| 74ABT126 v.3   | 20021213  | Product specification | -             | 74ABT126 v.2 |
| 74ABT126 v.2   | 19980116  | Product specification | -             | 74ABT126 v.1 |
| 74ABT126 v.1   | -   | -                     | -             | -            |

## 14 Legal information

### 14.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

### 14.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

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